

## **NEWS RELEASE**

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### **THE ISSUE OF USD50 MILLION 3% GUARANTEED CONVERTIBLE BONDS DUE 2009**

KUALA LUMPUR, 4 FEB 2005 – Unisem (M) Berhad (“Unisem”) announced today that the Company has successfully raised USD50 million through an issue of convertible bonds by its wholly-owned subsidiary, Unisem International (Labuan) Limited. The said transaction, which involved the issuance of USD50 million nominal value guaranteed convertible bonds on 3 February 2005, represents the second tranche of a USD150 million convertible bonds issue (“Second Tranche”). The first tranche of USD100 million was issued on 12 February 2004. The bonds are convertible into ordinary shares in, and guaranteed by, Unisem. Lehman Brothers International (Europe) acted as Sole Bookrunner for the Second Tranche.

The Second Tranche was approximately 1.5 times oversubscribed with approximately 70% of the issue placed to European investors and approximately 30% with Asian investors.

The convertible bonds pay a 3% cash coupon semi annually until the bonds expire in approximately four years, on 12 February 2009. On 3 August 2007 and 3 August 2008, investors have the opportunity to sell back, or put, the bonds to the issuer at 106.600% and 109.504%, respectively, providing a yield of 5.5%. Payment upon final redemption of the bonds has been set at 111.093%, also equivalent to a yield of 5.5%. The issue was priced on 28 January 2005. Investors can convert the bonds into shares of Unisem at a price of RM7.75 per share, representing a premium of approximately 14% to the closing price of the shares of Unisem on 27 January 2005. The conversion price will be adjusted on 3 February 2006, 3 February 2007 and 3 February 2008 as described in the offering circular. The net proceeds of the issue are to be used mainly for capital expenditure, the acquisition of existing plant or other packaging and test companies and for general working capital requirements.

Further details on the terms and conditions of the convertible bonds under the Second Tranche are set out in the Company’s announcement dated 28 January 2005.

#### **About Unisem (M) Berhad ([www.unisem.com.my](http://www.unisem.com.my))**

Unisem (M) Berhad, a leading semiconductor packaging and test services company in Malaysia, has its main packaging and test facilities in Ipoh, Malaysia with additional packaging and testing facilities in Wales, United Kingdom. Unisem offers an integrated suite of packaging and test services for semiconductor companies such as wafer probe, a wide range of leadframe and substrate IC packaging, high-end RF and mix-signal test, tape & reel and drop-shipment services.